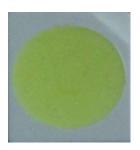
SPECTRAFILL Green LED

ESL2G11

Broadband Light-emitting Diode

Spectrafill green LED is a broadband (wide emission spectrum) solid-state light emitter. Its spectral width is roughly three times wider than that of usual narrow band LEDs. The polychromatic emission from this device contains correspondingly more shades of green color, making it suitable for high fidelity illumination applications. This LED can be used on its own or as one of a red, green, blue (RGB) full color LED set. The device is available in through hole, surface mount and power packages. The figure on the right shows the low power surface mount version of Spectrafill Green LED.



Typical Applications

- Decorative and architectural RGB lighting systems
- Broadband green lighting for machine vision applications
- Spectroscopy and microscopy
- Projector lamps and scanners

Key Features

- Broad emission in the green region
- Emitted light contains yellow and blue components as well
- •Lead free and RoHS compliant
- ESD and reverse voltage protection

Principal Parameters

Forward voltage drop: 3.0 V Peak emission wavelength: 507 nm Wavelength spread (FWHM): 104 nm

Emission angle: 120°

Typical CIE chromaticity coordinates: 0.32 (x), 0.52 (y) Typical luminous intensity (low power LED): 8000 mcd Typical luminous intensity (high power LED): 75 Lumens Typical operating current (low power LED): 20 mA Typical operating current (high power LED): 250 mA Operating temperature range: -40 °C to 80 °C

Lifetime: 30,000 hours Lens geometry: Round

Absolute Maximum Ratings

Maximum continuous operating Current (low power LED): 30 mA Maximum continuous operating Current (high power LED): 300 mA Maximum power dissipation (low

power LED): 120 mW

Maximum power dissipation (high

power LED): 1W

Maximum reverse voltage: 5 V

Maximum soldering

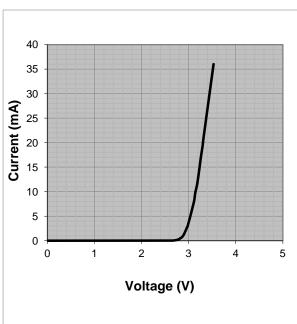
temperature: 280 °C for 5 sec

Packaging: ESL2G11 is available in T-1 $\frac{3}{4}$ 5 mm diameter through hole transparent epoxy package plastic leaded chip carrier (PLCC) surface mount device (SMD) 3528 package and 1W power package.

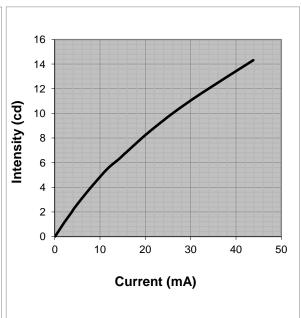


Electrical and Optical Characteristics

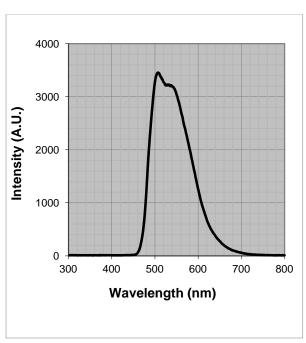
Current-voltage characteristics



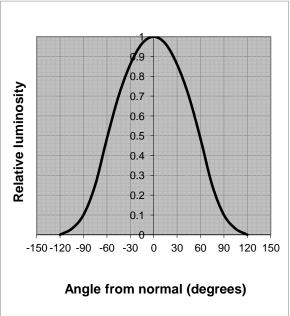
Light intensity versus LED drive current



Optical spectrum



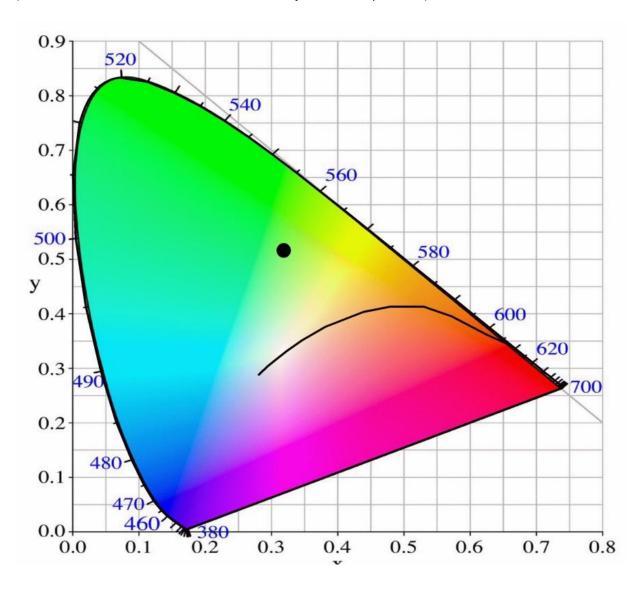
Angular light emission pattern





CIE Chromaticity Diagram

(Measured at 20 mA drive current at 25 °C LED junction temperature)



CIE chromaticity coordinates: X = 0.3183 Y = 0.5163

Application Information

General

Spectrafill LEDs can be operated in both continuous and pulsed modes. The latter may power-efficient in more certain applications. Like other LEDs, these devices start emitting light once their forward voltage drop exceeds their emission threshold. Thereafter, the light continues to increase in intensity as the drive current increases. The output optical power begins to saturate at high drive currents due to carrier saturation and thermal effects. This saturation is reached at lower currents when the device is operated at higher ambient temperatures. Adequate heat sinking must be provided to ensure satisfactory performance in terms of optical output, lumens maintenance and device lifetime. See more about this in the Design Considerations section below.

Analog Drive

Spectrafill LEDs can be driven by a continuous current drive. A stable, high impedance current source is recommended for this purpose. There are both fixed and variable current sources commercially available that are suitable for this purpose. Fixed current sources, such as NSI45030AT1G from ON Semiconductor provide a set current through an LED whereas the current output from a variable source, such as the PSSI2021SAY from NXP or the LM134 from Linear Technology can be adjusted using a trimming resistor. The current drive from all these and other similar devices is stable enough to drive Spectrafill LEDs at constant brightness and color point.

Digital Drive

For more precise control and reproducible color generation, Spectrafill LEDs can be driven by a digital pulse width modulation (PWM) signal. Generally, 8 bit precision is sufficient for most applications but if needed 10 or 16 bit systems can also be implemented.

This approach requires the use of either a microcontroller or a dedicated generator. Most general-purpose microcontrollers are suitable for application although some manufacturers also offer devices optimized for lighting control. Please note that digital drive requires a MOSFET power driver external to the microcontroller in order to handle the drive current requirements of Spectrafill LEDs. Electrospell can provide details of a reference design based on Atmel microcontrollers.

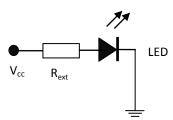
Design Considerations

Good electrical, thermal and optical designs Are the keys to obtaining good performance? From LEDs. Please make sure that stable, noise-free power is provided to these LEDs for best performance and long operating life. This can be done by placing a voltage regulator before the constant current source that drives LEDs. Also make sure that printed circuit board (PCB) tracks are wide and thick enough to handle current fed to LEDs. These devices should be mounted with proper heat sinking if they are to be driven at high power levels. Placing the LED package body on a metal core PCB (MC-PCB) or in contact with a metal heat sink is recommended. Filling the space between the LED and the heat sink with a suitable thermal interface material, such as Thermodime, is also recommended. Please note that significant increase of LED temperature can lead to reduced premature performance and Spectrafill LEDs emit light in a circularly symmetric Lambertian pattern with most light emitted normal to the device and the intensity falling at larger angles from the normal according to a cosine distribution function. In order to collect the maximum amount of light, proper reflectors should be used. These could be a feature of the product housing or can be inserted as accessory components. Proper choice and placement of reflector can maximize the amount of light that can be obtained from a lighting system.

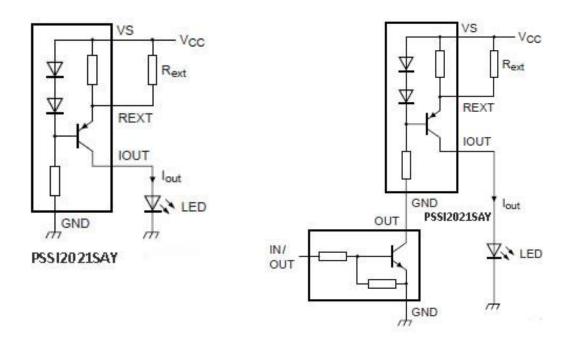


Circuit Examples

A simple resistor-connected circuit such as the one shown below can be used to drive Spectrafill LEDs. For most applications, a current between 20 and 30 mA will drive the LED at sufficient brightness. Power LED can be driven similarly at higher current levels, using a resistor with a suitable power rating.



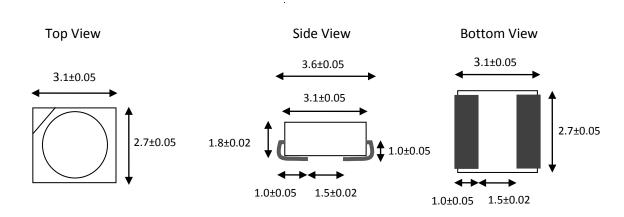
For better performance, where the supply voltage can change, use of constant current sources is recommended. The PSSI202SAY constant current IC can be used for this purpose for currents up to 50 mA, as shown below. Please refer to the PSSI202SAY datasheet for further information. For higher currents, use a transistor-based constant current source.



For digital PWM drive at low current levels, low power Spectrafill LEDs can be directly connected to microcontroller I/O pins with a suitable series resistor. For driving power Spectrafill LEDs, a power interface circuit using a MOSFET such as IRFZ34 and a MOSFET driver such as LT1910 are needed. Please contact Electrospell for further information about LED drive electronics.



SMD PLCC (3528) Package Drawing - All dimensions are in mm

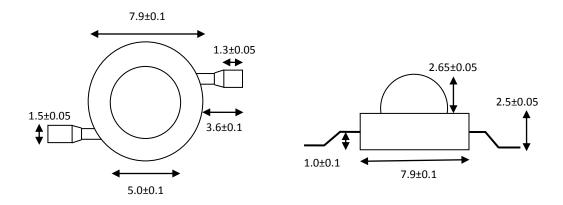


Emitting Aperture Diameter: 2.5 mm

Through-hole (T1-3/4) Package Drawing - All dimensions are in mm



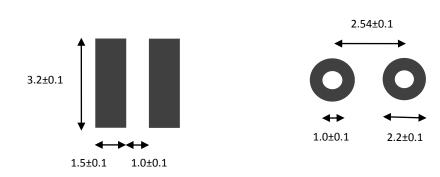
1W Power Package Drawing - All dimensions are in mm



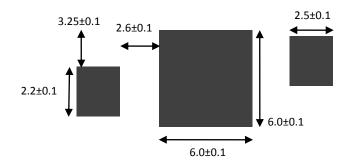
Note: Drawings are not to scale - to obtain values in inches, multiply by 0.04



Recommended land pattern and through-hole solder pattern



Recommended land pattern for 1W power package



Note: Drawings are not to scale - to obtain values in inches, multiply by 0.04



Product availability and ordering information

Spectrafill Green LEDs are available in the following three packaging styles:

Through hole T-1 ¾ (5 mm diameter) clear epoxy package [Longer lead identifies the anode (+) terminal] Product code: ESL2G11-TH01



Surface Mount Device PLCC plastic package [Corner depression identifies the cathode (-) terminal] Product code: ESL2G11-SMD01

This product is also available in 1000 piece tape-and-reel packaging in moisture-sealed bags.



Surface Mount Power LED package [Circular notch on solder terminal identifies the Cathode (-) terminal] Product code: ESL2G11-P01



This product is available in tube packaging. This product is also available in 50 piece trays contained in moisture-sealed bags.

Handling information

Spectrafill LEDs are static and moisture sensitive. Handle devices with appropriate precautions against electrostatic charge transfer to LEDs. Once a sealed LED package is open, reflow solder LEDs as soon as possible and in all cases within six months of package opening date. Baking devices before soldering is highly recommended and is essential if LEDs have not been stored in a dry environment. Recommended baking is at 110 °C for one hour or 70 °C for seven to eight hours.

To purchase Spectrafill Green LEDs please contact Electrospell using the contact information below.

Electrospell/PRP Inc 4200 E La Palma Avenue Anaheim CA 92807 United States of America Tel: (714)-528-5001

E-mail: sales@electrospell.com

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